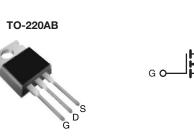


**Vishay Siliconix** 

## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	400				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.55			
Q <sub>g</sub> (Max.) (nC)	63				
Q <sub>gs</sub> (nC)	9.0				
Q <sub>gd</sub> (nC)	32				
Configuration	Single				



S N-Channel MOSFET

### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740PbF
	SiHF740-E3
SnPb	IRF740
	SiHF740

ABSOLUTE MAXIMUM RATINGS ( $T_{\text{C}}$	= 25 °C, unl	ess otherwis	se noted)		-	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	400	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	$V_{\rm res}$ of 10 V	T <sub>C</sub> = 25 °C		10		
	V <sub>GS</sub> at 10 V	$T_C = 100 \ ^\circ C$	ID	6.3	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	40		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	520	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	10	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	P <sub>D</sub> 125		W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)			300 <sup>d</sup>			
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 9.1 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 10$  A (see fig. 12).

c.  $I_{SD} \leq 10$  A, dl/dt  $\leq 120$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 -			°C/W				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>								
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 1.0							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	nless otherw	ise noted)							
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	0 V, I <sub>D</sub> = 2	50 µA	400	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I <sub>D</sub> = 1 mA	1	0.49	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\;\mu A$			2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$			1	-	± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	μA		
Zero date voltage Drain ourrent	IDSS	V <sub>DS</sub> = 320 V, V	$V_{DS}$ = 320 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 $^{\circ}\text{C}$		-	-	250	μΛ	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	ار	<sub>D</sub> = 6.0 A <sup>b</sup>	1	-	0.55	Ω	
Forward Transconductance	<b>g</b> <sub>fs</sub>	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 6.0 \text{ A}^{b}$		5.8	-	-	S		
Dynamic						_	_		
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1.0 MHz, see fig. 5			I	1400	-	pF	
Output Capacitance	C <sub>oss</sub>				-	330	-		
Reverse Transfer Capacitance	C <sub>rss</sub>				-	120	-		
Total Gate Charge	$Q_g$				-	-	63		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V},$	-	-	9.0	nC			
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>	-	-	32			
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	-		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 200 V, I <sub>D</sub> = 10 A R <sub>g</sub> = 9.1 Ω, R <sub>D</sub> = 20 Ω, see fig. 10 <sup>b</sup>		= 10 A	-	27	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	50	-	ns		
Fall Time	t <sub>f</sub>			-	24	-			
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	L <sub>S</sub>			-	7.5	-			
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	А		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	40			
Body Diode Voltage	V <sub>SD</sub>	$T_{\rm J} = 25 \ ^{\circ}\text{C}, I_{\rm S} = 10 \text{ A}, V_{\rm GS} = 0 \ V^{\rm b}$		-	-	2.0	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{\text{b}}$		-	370	790	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	3.8	8.2	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is do	minated b	vland	1	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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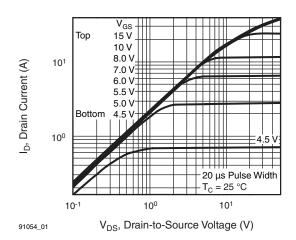


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

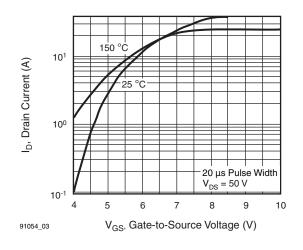


Fig. 3 - Typical Transfer Characteristics

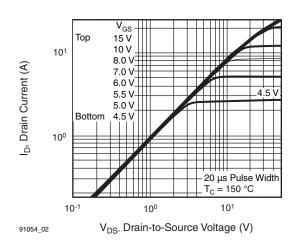


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \ ^{\circ}C$ 

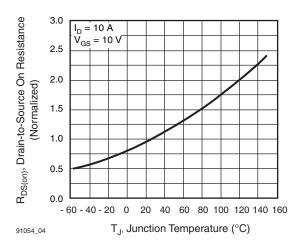
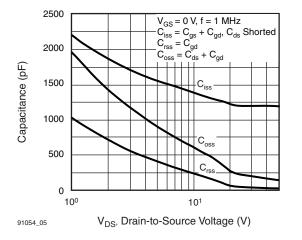


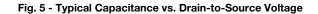
Fig. 4 - Normalized On-Resistance vs. Temperature

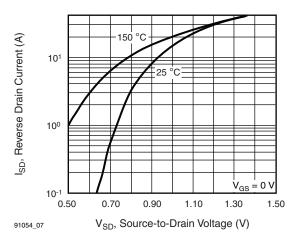
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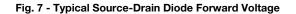
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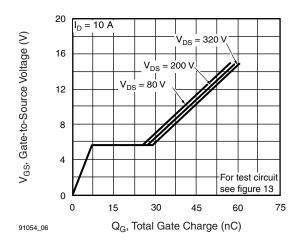


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

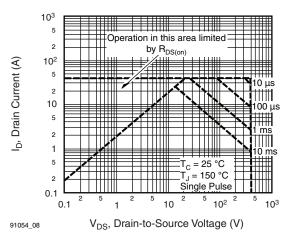


Fig. 8 - Maximum Safe Operating Area

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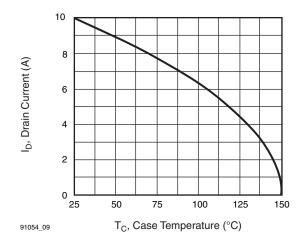


Fig. 9 - Maximum Drain Current vs. Case Temperature

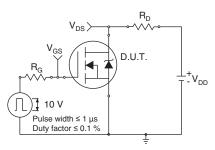


Fig. 10a - Switching Time Test Circuit

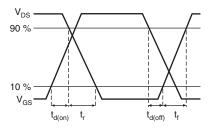


Fig. 10b - Switching Time Waveforms

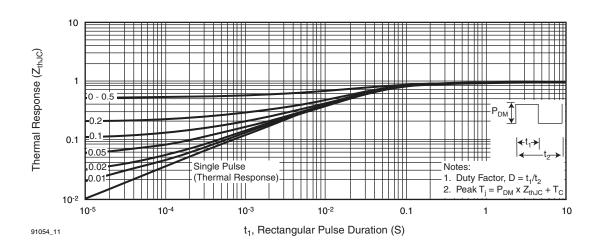


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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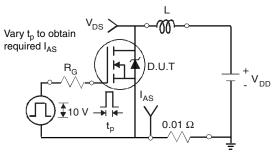


Fig. 12a - Unclamped Inductive Test Circuit

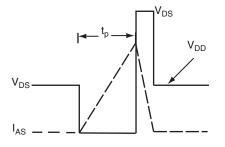
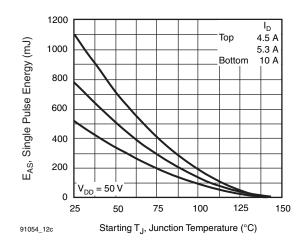
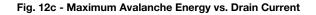


Fig. 12b - Unclamped Inductive Waveforms





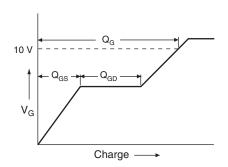


Fig. 13a - Basic Gate Charge Waveform

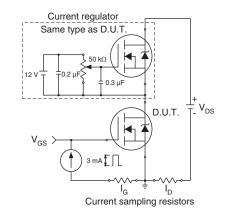
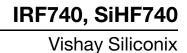


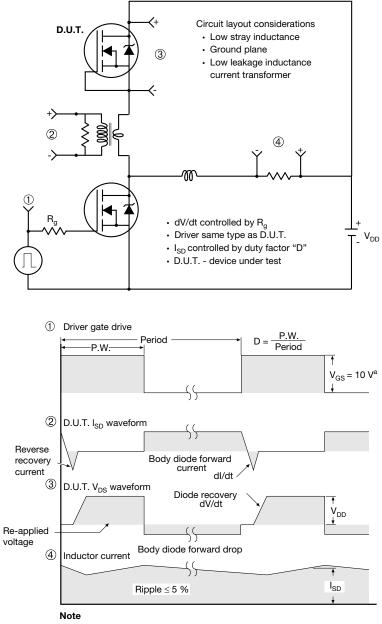
Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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